

40-6553-10 Information


For Reference Only

Part Number 40-6553-10
Manufacturer Aries Electronics
Category Connectors, Interconnects
Sockets for ICs, Transistors
Description CONN IC DIP SOCKET ZIF 40POS GLD
Package -
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com



[Request a Quote](#)

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


40-6553-10 Specifications

Manufacturer Part Number	40-6553-10
Manufacturer	Aries Electronics
Category	Connectors, Interconnects Sockets for ICs, Transistors
Package	-
Series	55
Type	DIP, ZIF (ZIP), 0.6" (15.24mm) Row Spacing
Number of Positions or Pins (Grid)	40 (2 x 20)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	-
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	-
Contact Material - Post	Beryllium Copper
Housing Material	Polyphenylene Sulfide (PPS), Glass Filled
Operating Temperature	-

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40-6553-10 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

40-6553-10 Payment Methods



40-6553-10 Shipping Methods



If you have any question about 40-6553-10, please do not hesitate to contact us!

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